4096 BIT (1024 × 4 BITS) STATIC RAM

DESCRIPTION

The NEC μPD2114L is a 4096 bit static Random Access Memory organized as 1024 words by 4 bits using N-channel Silicon-gate MOS technology. It uses fully DC stable (static) circuitry throughout, in both the array and the decoding. It therefore requires no clocks or refreshing to operate and simplifies system design. The data is read out nondestructively and has the same polarity as the input data. Common input/output pins are provided.

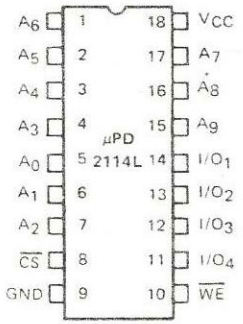
The μPD2114L is designed for memory applications where high performance, low cost, large bit storage, and simple interfacing are important design objectives. The μPD2114L is placed in an 18-pin package for the highest possible density.

It is directly TTL compatible in all respects: inputs, outputs, and a single +5V supply. A separate Chip Select ($\overline{CS}$) lead allows easy selection of an individual package when outputs are OR-Tied.

FEATURES

- Access Time: Selection from 150-450 ns
- Single +5 Volt Supply
- Directly TTL Compatible – All Inputs and Outputs
- Completely Static – No Clock or Timing Strobe Required
- Low Operating Power – Typically 0.06 mW/Bit
- Identical Cycle and Access Times
- Common Data Input and Output using Three-State Output
- High Density 18-pin Plastic and Ceramic Packages
- Replacement for 2114L and Equivalent Devices

PIN CONFIGURATION

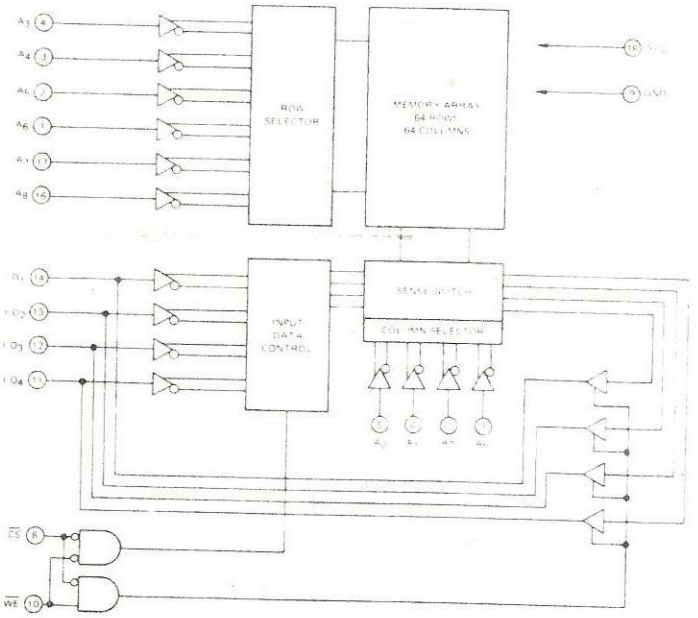


PIN NAMES

A_0-A_9	Address Inputs
$\overline{WE}$	Write Enable
$\overline{CS}$	Chip Select
I/O_1-I/O_4	Data Input/Output
V_{CC}	Power (+5V)
GND	Ground

Rev/2

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS*

Operating Temperature	-10°C to +80°C
Storage Temperature	-65°C to +150°C
Voltage on any Pin	-0.5 to 7 Volts ①

Note: ① With respect to ground.

$T_a = 25°C$

*COMMENT: Stress above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS

$T_a = 0°C$ to $70°C$; $V_{CC} = +5V \pm 10\%$ unless otherwise noted.

PARAMETER	SYMBOL	LIMITS MIN	LIMITS TYP	LIMITS MAX	UNIT	TEST CONDITIONS
Input Load Current (All Input Pins)	I_{LI}			10	μA	$V_{IN} = 0$ to 5.5V
I/O Leakage Current	I_{LO}			10	μA	$\overline{CS} = 2V$, $V_{I/O} = 0.4V$ to V_{CC}
Power Supply Current	I_{CC1}			65	mA	$V_{IN} = 5.5V$, $I_{I/O} = 0$ mA, $T_a = 25°C$
Power Supply Current	I_{CC2}			70	mA	$V_{IN} = 5.5V$, $I_{I/O} = 0$ mA, $T_a = 0°C$
Input Low Voltage	V_{IL}	-3.0		0.8	V	
Input High Voltage	V_{IH}	2.0		6.0	V	
Output Low Current	I_{OL}	3.2			mA	$V_{OL} = 0.4V$
Output High Current	I_{OH}			-1.0	mA	$V_{OH} = 2.4V$, $V_{CC} = 4.75V$
						$V_{OH} = 2.2V$, $V_{CC} = 4.5V$

CAPACITANCE

$T_a = 25°C$; $f = 1.0$ MHz

PARAMETER	SYMBOL	LIMITS MIN	LIMITS TYP	LIMITS MAX	UNIT	TEST CONDITIONS
Input/Output Capacitance	$C_{I/O}$			8	pf	$V_{I/O} = 0V$
Input Capacitance	C_{IN}			5	pf	$V_{IN} = 0V$

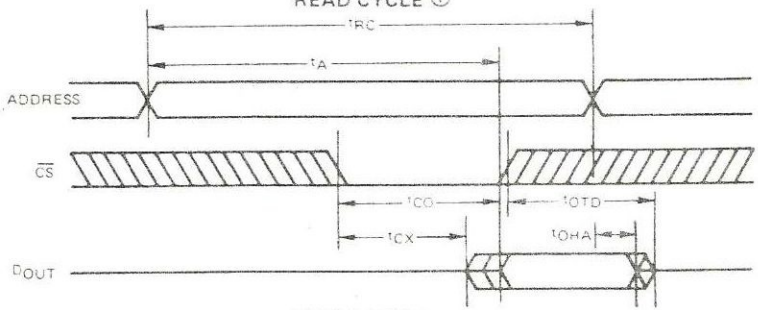
AC CHARACTERISTICS

T_a = 0°C to +70°C, V_{CC} = +5V ± 10%, unless otherwise noted

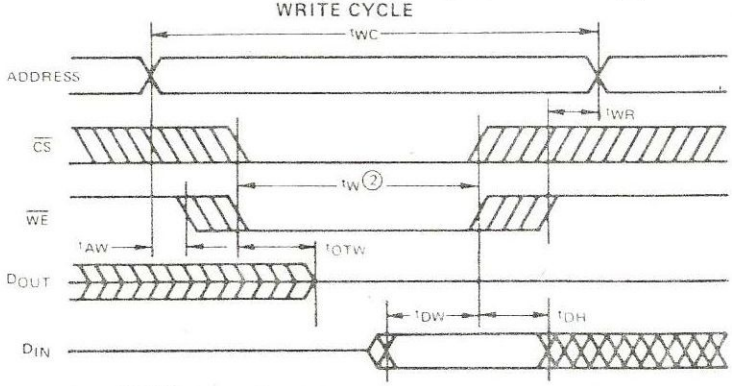
PARAMETER	SYMBOL	LIMITS										UNIT	TEST CONDITIONS
		2114L		2114L-1		2114L-2		2114L-3		2114L-5			
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
READ CYCLE													
Read Cycle Time	t_{RC}	450		300		250		200		150		ns	$t_T = t_r = t_f = 10$ ns
Access Time	t_A		450		300		250		200		150	ns	C_L = 100 pF
Chip Selection to Output Valid	t_{CO}		120		100		80		70		60	ns	Load = 1 TTL gate
Chip Selection to Output Active	t_{CX}	20		20		20		20		20		ns	Input Levels = 0.8 and 2.0V
Output 3-State from Deselection	t_{OTD}		100		80		70		60		50	ns	V_{ref} = 1.5V
Output Hold from Address Change	t_{OHA}	50		50		50		50		50		ns	
WRITE CYCLE													
Write Cycle Time	t_{WC}	450		300		250		200		150		ns	$t_T = t_r = t_f = 10$ ns
Write Time	t_W	200		150		120		120		80		ns	C_L = 100 pF
Write Release Time	t_{WR}	0		0		0		0		0		ns	Load = 1 TTL gate
Output 3-State from Write	t_{OTW}		100		80		70		60		50	ns	Input Levels = 0.8 and 2.0V
Data to Write Time Overlap	t_{DW}	200		150		120		120		80		ns	V_{ref} = 1.5V
Data Hold from Write Time	t_{DH}	0		0		0		0		0		ns	
Address to Write Setup Time	t_{AW}	0		0		0		0		0		ns	

TIMING WAVEFORMS

READ CYCLE ①



WRITE CYCLE



Notes ① $\overline{WE}$ is high for Read Cycle

② t_W is measured from the latter of $\overline{CS}$ or $\overline{WE}$ going low to the earlier of $\overline{CS}$ or $\overline{WE}$ going high.